

FMI05N50E

FUJI POWER MOSFET

Super FAP-E³ series

N-CHANNEL SILICON POWER MOSFET

■ Features

Maintains both low power loss and low noise Lower $R_{DS}(on)$ characteristic More controllable switching dv/dt by gate resistance Smaller V_{GS} ringing waveform during switching Narrow band of the gate threshold voltage (3.0±0.5V) High avalanche durability

Applications

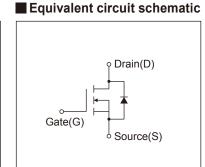
Switching regulators UPS (Uninterruptible Power Supply) DC-DC converters

■ Maximum Ratings and Characteristics

● Absolute Maximum Ratings at Tc=25°C (unless otherwise specified)

T-Pack(L) 104 1.219.2 1.219

■ Outline Drawings [mm]



Description	Symbol	Characteristics	Unit	Remarks	
Proin Source Voltage	V _{DS}	500	V		
Drain-Source Voltage	VDSX	500	V	V _{GS} = -30V	
Continuous Drain Current	In	±5	А		
Pulsed Drain Current	IDP	±20	A		
Gate-Source Voltage	V _{GS}	±30	V		
Repetitive and Non-Repetitive Maximum Avalanche Current	IAR	5	A	Note*1	
Non-Repetitive Maximum Avalanche Energy	Eas	171	mJ	Note*2	
Repetitive Maximum Avalanche Energy	Ear	6.0	mJ	Note*3	
Peak Diode Recovery dV/dt	dV/dt	5.3	kV/μs	Note*4	
Peak Diode Recovery -di/dt	-di/dt	100	A/µs	Note*5	
Maximum Power Dissipation	PD	1.67	W	Ta=25°C	
		60) VV	Tc=25°C	
Operating and Storage Temperature range	Tch	150	°C		
	T _{stg}	-55 to +150	°C		

Electrical Characteristics at Tc=25°C (unless otherwise specified)

Description	Symbol	Conditions	Conditions		typ.	max.	Unit
Drain-Source Breakdown Voltage	BVoss	In=250µA, Vgs=0V	I _D =250µA, V _{GS} =0V		-	-	V
Gate Threshold Voltage	V _{GS} (th)	In=250µA, Vns=Vs	I _D =250µA, V _{DS} =V _{GS}		3.0	3.5	V
Zero Gate Voltage Drain Current	Ipss	V _{DS} =500V, V _{GS} =0V	Tch=25°C	-	-	25	μA
	IDSS	V _{DS} =400V, V _{GS} =0V	Tch=125°C	-	-	250	
Gate-Source Leakage Current	Igss	V _{GS} =±30V, V _{DS} =0V		-	10	100	nA
Drain-Source On-State Resistance	R _{DS} (on)	I _D =2.5A, V _{GS} =10V		-	1.28	1.50	Ω
Forward Transconductance	g _{fs}	I _D =2.5A, V _{DS} =25V		2.5	5	-	S
Input Capacitance	Ciss	V _{DS} =25V		-	610	915	pF
Output Capacitance	Coss	V _{GS} =0V	V _{GS} =0V		66	99	
Reverse Transfer Capacitance	Crss	f=1MHz		-	4.7	7.1	
Turn-On Time	td(on)	V _{cc} =300V V _{cs} =10V I _D =2.5A R _c =24Ω		-	10	15	ns
	tr			-	7	10.5	
Turn-Off Time	td(off)			-	45	67.5	
	tf			-	13.5	20.3	
Total Gate Charge	QG	Vcc=250V	V _{cc} =250V I _D =5A V _{cs} =10V		21	32	nC
Gate-Source Charge	QGS	In=5A			6	9	
Gate-Drain Charge	Q _{GD}	V _{GS} =10V			5.5	8.3	
Avalanche Capability	lav	L=5.01mH, Tch=25°C	L=5.01mH, Tch=25°C		-	-	Α
Diode Forward On-Voltage	V _{SD}	I _F =5A, V _{GS} =0V, T _{ch} =25°C	I _F =5A, V _{GS} =0V, T _{ch} =25°C		0.86	1.30	V
Reverse Recovery Time	trr	I _F =5A, V _{GS} =0V	I _F =5A, V _{GS} =0V		0.28	-	μs
Reverse Recovery Charge	Qrr	-di/dt=100A/µs, Tch=25°C		-	1.8	-	μC

Thermal Characteristics

Description	Symbol	Test Conditions	min.	typ.	max.	Unit
Thermal resistance	Rth (ch-c)	Channel to Case			1.200	°C/W
	Rth (ch-a)	Channel to Ambient			75.0	°C/W

Note *1 : Tch≤150°C

Note *2 : Stating Tch=25°C, I_{AS}=2A, L=78.3mH, Vcc=50V, R_G=50Ω

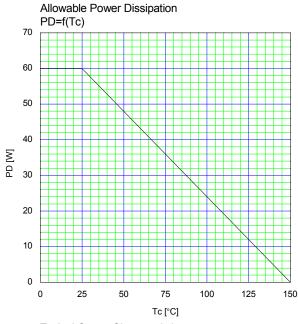
E_{AS} limited by maximum channel temperature and avalanche current.

See to 'Avalanche Energy' graph.

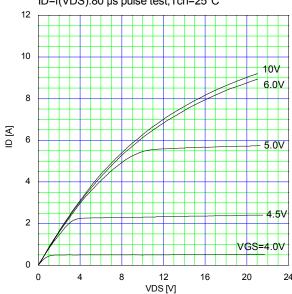
Note *3 : Repetitive rating : Pulse width limited by maximum channel temperature.

See to the 'Transient Themal impeadance' graph.

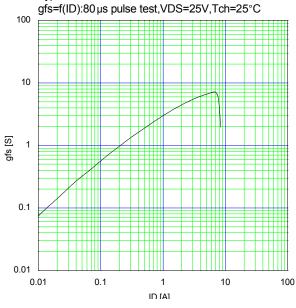
Note *4 : I_F≤-I_D, -di/dt=100A/µs, Vcc≤BV_{DSS}, Tch≤150°C. Note *5 : I_F≤-I_D, dv/dt=5.3kV/µs, Vcc≤BV_{DSS}, Tch≤150°C.



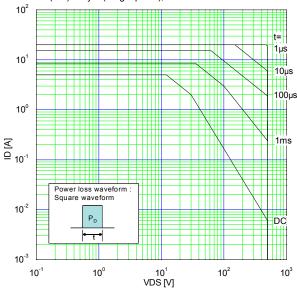
Typical Output Characteristics ID=f(VDS):80 µs pulse test, Tch=25°C



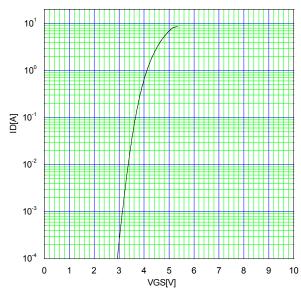
Typical Transconductance



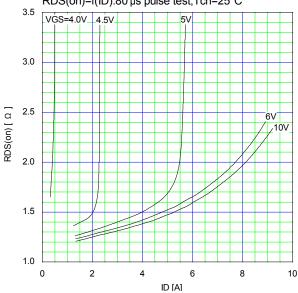
Safe Operating Area Ib=f(Vbs):Duty=0(Single pulse),Tc=25°c

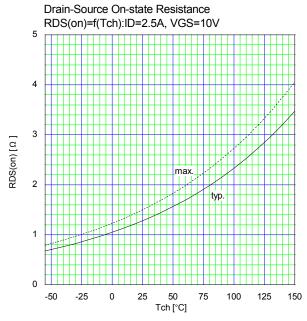


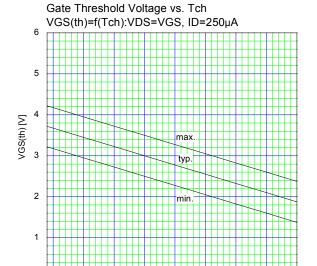
Typical Transfer Characteristic ID=f(VGS):80 µs pulse test,VDS=25V,Tch=25°C



Typical Drain-Source on-state Resistance RDS(on)=f(ID):80 µs pulse test,Tch=25°C







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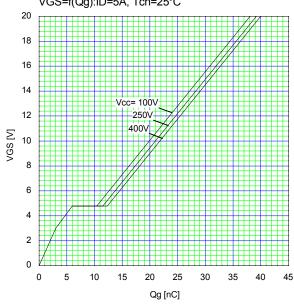
Tch [°C]

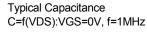
100

125

150

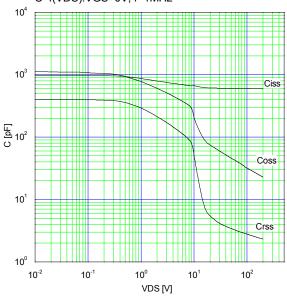
Typical Gate Charge Characteristics VGS=f(Qg):ID=5A, Tch=25°C



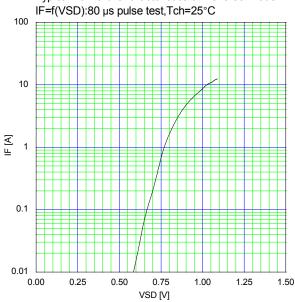


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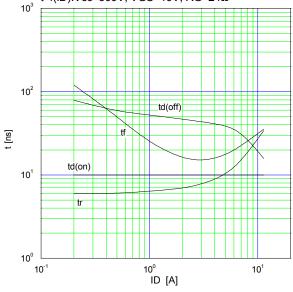
0



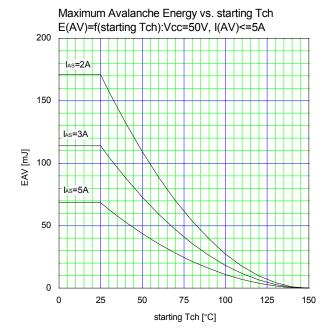
Typical Forward Characteristics of Reverse Diode

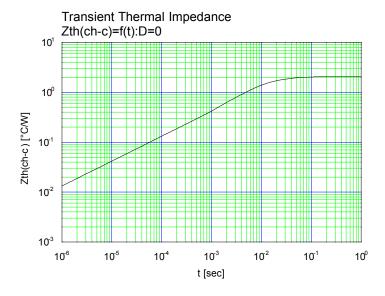


Typical Switching Characteristics vs. ID t=f(ID):Vcc=300V, VGS=10V, RG=24Ω



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